Onsemi

MOSFET – N-Channel, **UniFET**[™]

500 V, 18 A, 265 mΩ

FDP18N50 / FDPF18N50 / FDPF18N50T

Description

UniFET MOSFET is onsemi's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

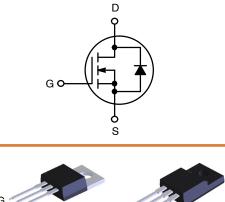
Features

- $R_{DS(on)} = 220 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 9 \text{ A}$
- Low Gate Charge (Typ. 45 nC)
- Low C_{rss} (Typ. 25 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply

V _{DS}	R _{DS(ON)} MAX	I _D MAX
500 V	265 mΩ @ 9 V	18 A



TO-220-3LD CASE 340AT

TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT

MARKING DIAGRAM

ס'

	FDP 18N50T AYWWZZ		FDPF 18N50 18N50T AYWWZZ	
FDF	= A W = D	ssembly L	(Year and Wee	ek)

ORDERING INFORMATION

Device	Package	Shipping
FDP18N50	TO-220	1000 Units / Tube
FDPF18N50	TO-220F	1000 Units / Tube
FDPF18N50T	TO-220F	1000 Units / Tube

MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	FDP18N50	FDPF18N50 / FDPF18N50T	Unit	
V _{DSS}	Drain to Source Voltage		5	500	
Ι _D		- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	18 10.8	18* 10.8*	A
I _{DM}	Drain Current -	- Pulsed (Note 1)	72	72*	А
V _{GSS}	Gate to Source Voltage		±30		V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		9	945	
I _{AR}	Avalanche Current (Note 1)		18		А
E _{AR}	Repetitive Avalanche Energy (Note 1)		23	3.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns
P _D	Power Dissipation $(T_C = 25^{\circ}C)$ 235- Derate Above 25^{\circ}C1.88		38.5 0.3	W W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to	o +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Second		3	00	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. L = 5.2 mH, I_{AS} = 18 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C 3. $I_{SD} \le 18$ A, di/dt ≤ 200 A/µs, $V_{DD} \le BV_{DSS}$, Starting T_J = 25°C

THERMAL CHARACTERISTICS

Symbol	Parameter	FDP18N50	FDPF18N50 / FDPF18N50T	Unit
Rejc	Thermal Resistance, Junction-to-Case, Max.	0.53	3.3	°C/W
Reja	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARAC	TERISTICS					-
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0, I_D = 250 \ \mu A,$	500	_	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C	-	0.5	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
		V_{DS} = 400 V, T_{C} = 125°C	-	-	10	
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reserve	$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARACT	ERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 9 A	-	0.220	0.265	Ω
9 FS	Forward Transconductance	V _{DS} = 40 V, I _D = 9 A	-	25	-	S
DYNAMIC CHA	ARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	2200	2860	pF
Coss	Output Capacitance		_	330	430	pF
C _{rss}	Reverse Transfer Capacitance	7	-	25	40	pF

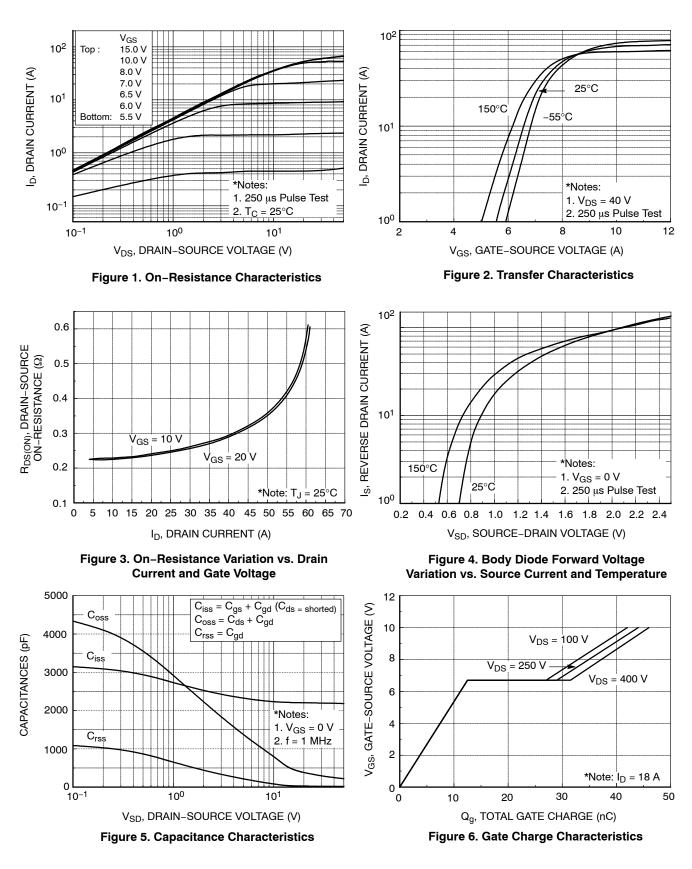
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
SWITCHING C	HARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 18 \text{ A},$	-	55	120	ns
t _r	Turn–On Rise Time	V _{GS} = 10 V,R _G = 25 Ω (Note 4)	-	165	340	ns
t _{d(off)}	Turn-Off Delay Time		-	95	200	ns
t _f	Turn-Off Fall Time		-	90	190	ns
Qg	Total Gate Charge	V _{DS} = 400 V, I _D = 18 A, V _{GS} = 10 V (Note 4)	-	45	60	nC
Q _{gs}	Gate-Source Charge		-	12.5	-	nC
Q _{gd}	Gate-Drain Charge		-	19	-	nC
DRAIN-SOUR	CE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS				
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	18	А
I _{SM}	Maximum Pulsed Drain- Source Diode Forward Current		-	-	72	А
V _{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 18 A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 18 A dI _F /dt = 100 A/μs	-	500	-	ns
Q _{rr}	Reverse Recovery Charge		-	5.4	_	μC

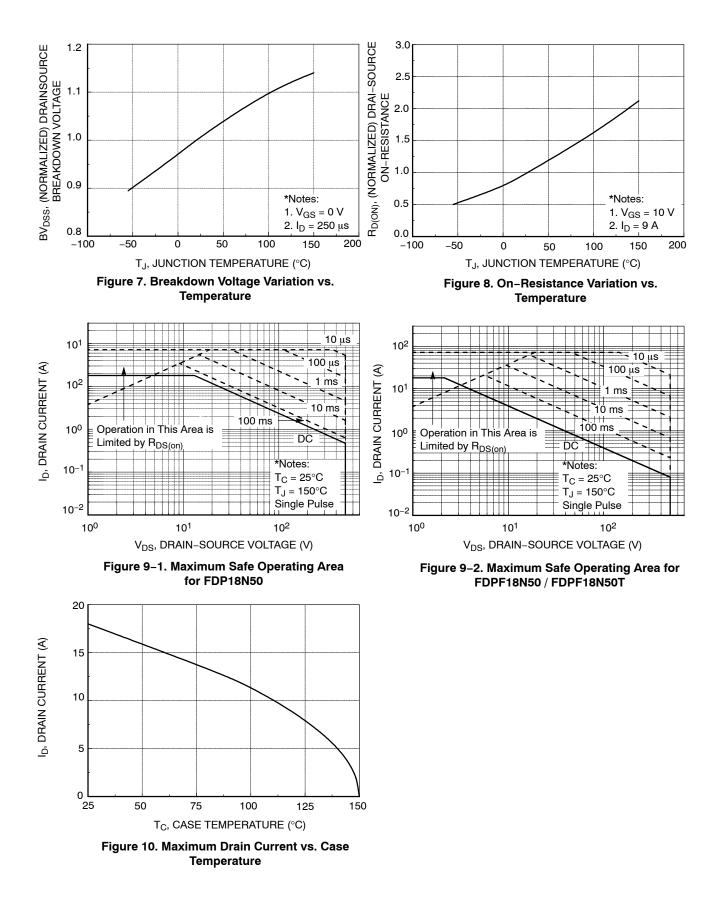
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially Independent of Operating Temperature Typical Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)



TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

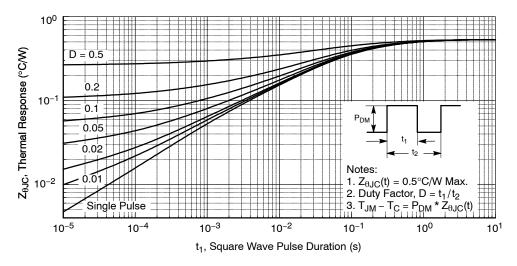


Figure 11 –1. Transient Thermal Response Curve – FDP18N50

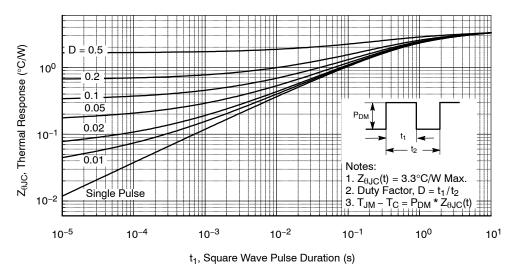
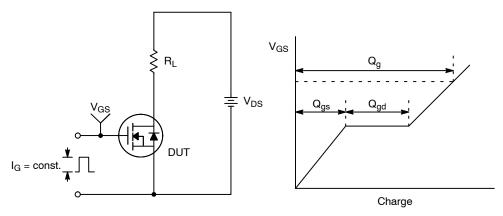


Figure 11 -2. Transient Thermal Response Curve - FDPF18N50 / FDPF18N50T





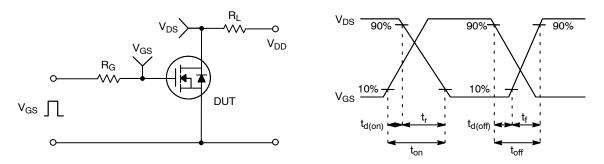


Figure 13. Resistive Switching Test Circuit & Waveforms

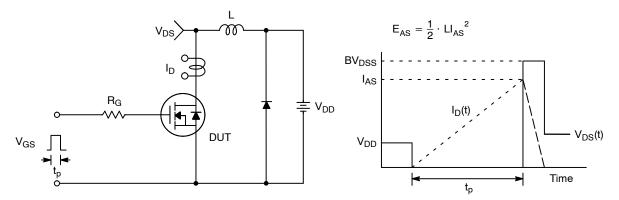


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

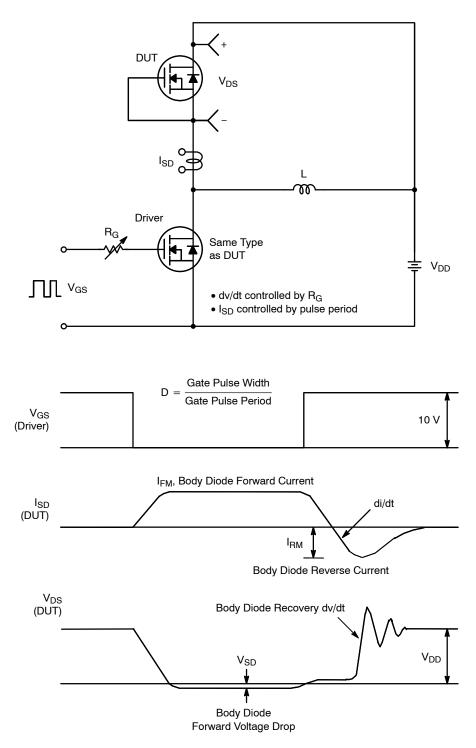
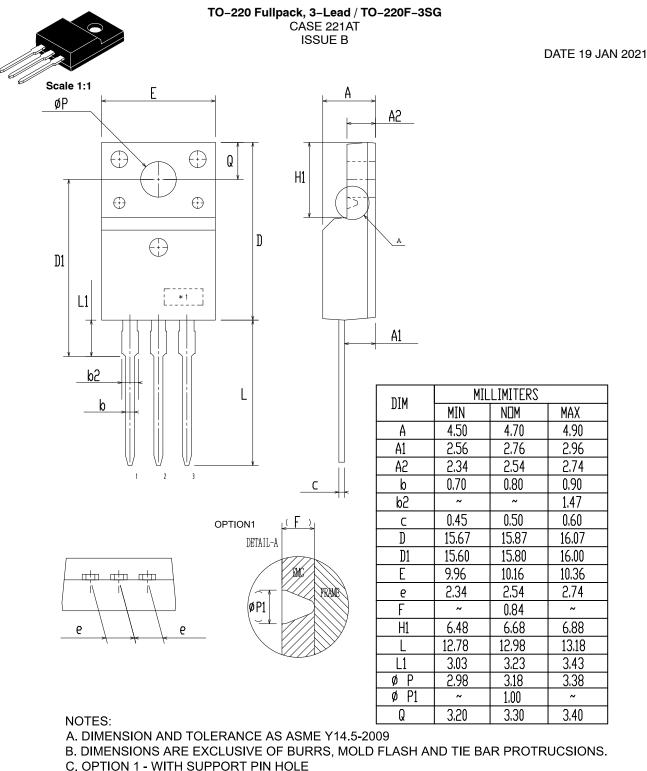


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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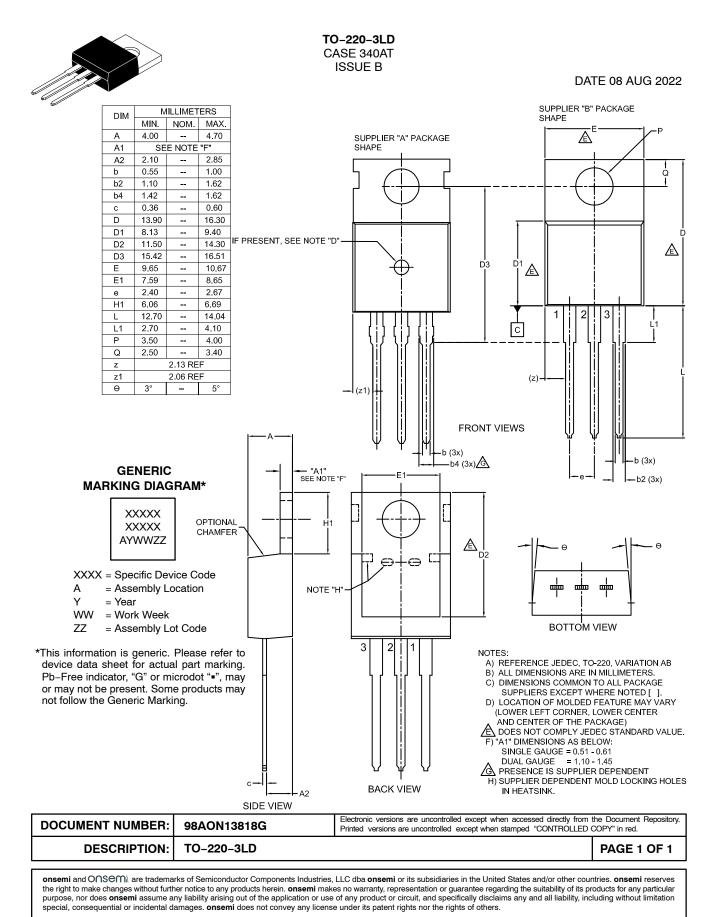


OPTION 2 - NO SUPPORT PIN HOLE

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